Samurai UV Class I Marking System

FEATURES

- ~ Up to 3 W Average Power
- ~ Up to 4 KW Peak Power
- ~ High Precision
- ~ Powerful, Easy-to-use Software
- Import Text and Graphics From Your Favorite Programs
- ~ Automation-Ready Industrial Design
- ~ Safe, Class I Enclosure
- Customizable Work Areas and Spot Sizes



The Samurai UV Marker is a fully integrated Class I benchtop UV marking system. Taking advantage of the photon energy of the 355 nm wavelength, the system is capable of achieving 7 um spot sizes and work spaces in excess of 300 x 300 mm. With the intuitive control software, you can go from design to marking within minutes of system start-up. The low-maintenance DPSS UV Laser offers years of trouble-free marking.

The Class I safety enclosure is designed to meet strict FDA safety guidelines while being easy to use and non-obtrusive. A large front door allows convenient access to the entire work area. Safety shielding protects the user from powerful UV beams, but allows 360 degree viewing of the work space.

The Class I Samurai UV Marker is designed to be as versatile as it is powerful. The system can operate independently on a benchtop or be fully integrated into your automated production process using industrial level I/O, software APIs, serial and Ethernet communication, PLCs and much more.



Silicon Wafer Marking

APPLICATIONS

- * Laser Marking
- Solar Cell Processing
- * Thick/Thin Film Laser Trimming
- * ITO Removal
- * Sapphire Scribing
- * Micromachining
- * Direct Write/Repair
- * Micro-via Hole Drilling
- * Wafer processing
- * Polyimide Cutting & Drilling
- * Photo Bleaching

SPECIFICATIONS

LASER PERFORMANCE

Wavelength 354.7 nm **Average Power** 1 - 3 W Energy per Pulse $< 100 \, \mu J$

Mode (M²) TEMoo $(M^2 < 1.3)$

Beam Diameter (1/e²) See Chart Pulse to Pulse Stability (30 - 100 kHz) < 15% Power Stability (8 hrs. at const. temp.) < 5% < 10% Ellipticity Astigmatism < 0.3

MARKING PERFORMANCE

Marking Accuracy < 1.5 mrad Marking Repeatability < 22 µrad

FI FCTRICAL

Input Voltage 90 - 240 VAC 900 W Power Consumption (max.) Ambient Temp. (non-condensing) 10 - 35° C

PHYSICAL

System Dim (LWH) 872 x 807 x 854 mm Marking Chamber Dim (LWH) 737 x 737 x 610 mm

System Weight 91 kg

Cooling System Dim. (LWH) 287 x 224 x 389 mm

Cooling System Weight (dry) 9 kg

Full system consists of laser head, laser controller, routing optics, galvo, cooling system, computer, marking software and all necessary cables.

Spot Size	Field Size	<u>f-Theta Lens</u>
7 um	16 x 16 mm	f-56 mm
20 um	160 x 160 mm	f-250 mm
25 um	205 x 205 mm	f-330 mm
30 um	80 x 80 mm	NA
FO	470 470	NIA
*Other Models Available Upon Requi	170 x 170 mm	NA hout notice









